Multilayer Ceramic Chip Capacitors How to Order



■Features

- •Kyocera's series of Multilayer Ceramic Chip Capacitors are designed to meet a wide variety of needs. We offer a complete range of products for both general and specialized applications.
- •We have a network worldwide in order to supply our global customer bases quickly and efficiently.
- •All our products are highly reliable due to their monolithic structure of high-purity and superfine uniform ceramics and their integral internal electrodes.
- Our stringent quality control in every phase of production from material procurement to shipping ensures consistent manufacturing and superior quality.
- Kyocera components are available in a wide choice of dimensions, temperature characteristics, rated voltages, and terminations to meet specific configurational requirements.



e.g.)

KGM 0J M

(5) (7)**(6)**

(8) Option Code (When needed)

: KGM Series(General) Series
 Size (EIA)

0201 ③ Thickness (max.): 0.39mm

: Operating Temperature Range: -55 to 85°C/ ΔC max.: ±15%/ Standard Temperature: 25°C

: 6.3Vdc : 2.2µF (5) Rated Voltage 6 Capacitance7 Tolerance : ±20%

: Taping Material Paper/ Taping Width 8mm/ (8) Packaging

Cavity Pitch 2mm/ Reel Size φ180

1 Series Code

CODE	Type	
KGM	General	
KGT	Low Profile	
KGU	High-Q	
KAM	Automotive	
KGN	Three Terminal Capacitors	

② Size Code

CODE	EIA	JIS
02	01005	0402
03	0201	0603
05	0402	1005
15	0603	1608
21	0805	2012
31	1206	3216
32	1210	3225

3 Thickness (max.)

CODE	EIA	JIS	Thickness Code	Thickness(max.)
02	01005	0402	Α	0.22
			Α	0.33
			В	0.35
03	0201	0603	С	0.39
			D	0.55
			Υ	0.22
			Α	0.55
			В	0.65
05	0402		С	0.7
		1005	D	0.8
			X	0.22
			Υ	0.33
			Z	0.5
15	0603	1608	Α	0.9
13	0003	1000	С	1.0
21	0805	2012	Α	1.45
21	0003	2012	С	0.95
			Α	1.8
31	1206	1206 3216	F	1.75
31	1206		Н	1.9
			L	0.95
32	1210	3225	А	2.7

(5) Voltage Code

CODE	Rated Voltage	CODE	Rated Voltage
0E	2.5Vdc	1E	25Vdc
0G	4Vdc	1V	35Vdc
OJ	6.3Vdc	1H	50Vdc
1A	10Vdc	2A	100Vdc
1C	16Vdc		

6 Capacitance Code

Capacitance expressed in pF. Two significant digits plus number of zeros. For Values < 10pF, Letter R denotes decimal point,

(Example)

<u> </u>	<u> </u>		
CODE	Capacitance	CODE	Capacitance
R50	0.5pF	103	10000pF
1R0	1pF	104	0.1µF
100	10pF	105	1µF
101	100pF	106	10µF
102	1000pF	107	100µF

(7) Tolerance Code

	Temperature Compensation Type(CG/CH)					
CODE	Tolerance					
A ±0.05pF						
B ±0.1pF						
C ±0.25pF						
D	D ±0.5pF					
G	G ±2%					
J	J ±5%					
K	±10%					

(R5,	High Dielectric Constant Type (R5/S6/T6/R7/K7/S7/T7)				
CODE	CODE Tolerance				
J*	J* ±5%				
K	K ±10%				
М	±20%				

^{* :} Option

4 Dielectric Code

	Temperature Compensation Type								
CODE	CODE Temperature Range(°C) ppm/°C								
CG	FF - 12F	CG −55 ~ 125 0	0	±30					
CH	-33.~ 123	U	±60						

·All parts of COG will be marked as "CG" but will conform to the above table.

Temperature coefficients are determined by calculation based on measurement at 20°C and 85°C.

	High Dielectric Constant Type								
CODE	Temperature Range(°C)	ΔC (%)	Reference Temp.°C						
R5	−55 ~ 85	±15							
S6	-55 ∼ 105	±22							
T6	-33 ~ 103	+22/-33							
R7		±15	25						
K7*	-55 ∼ 125	±15							
S7	-33 ~ 123	±22							
T7		+22/-33							

*Special spec: Change in capacitance under 50% of rated voltage applied.

Measurement conditions for temperature characteristics K7.

Applied voltage and Temperature step

Step	С	Applying Voltage	Temperature℃		
1	C0	CO No bias Reference Temp			
2	_		Reference Temp.		
3	C1	50% of	Min. Operating Temp.		
4	C2	Rated voltage	Reference Temp.		
5	C1		Max. Operating Temp.		

 $\Delta C/C(\%) = (C1-C2)/C0 \times 100$

C0:Capacitance value at step 1

C1:Capacitance value from step 3 to 5

C2:Capacitance value at step 4

Packaging Code

8 Packaging Code								
CODE	Size Code	Material	Width	Pitch	Reel size			
Т	15 to 31	Paper	8mm	4mm				
Н	02 to 05	Paper	8mm	2mm				
Q	03	Paper	8mm	1mm	φ180			
U	21 to 32	Plastic	8mm	4mm				
Р	02	Plastic	4mm	1mm				
М	15 / 21	Paper	8mm	4mm				
N	02 to 05	Paper	8mm	2mm	φ330			
W	03	Paper	8mm	1mm	ψυσο			
L	21 to 32	Plastic	8mm	4mm				

Multilayer Ceramic Chip Capacitors Dimension

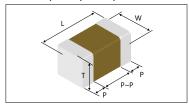


1mm

2mm

4mm

■KGM/KGT/KGU/KAM Series (Two Terminal Capacitors)



■ Packaging Code 20kp (E 8 / 2) kp means Taping Material Taping Width Pitch 1000 pieces Code Material Code Width Code Pitch

4mm

8mm

8

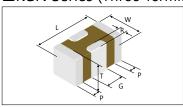
Plastic

Paper

Size	Со	de	Thickness		Dimension (mm)					Quantity	per reel					
Size	EIA	JIS	Code	L	W	Т	P min.	P max.	$P \sim P \text{ min.}$	φ180 Reel	φ330 Reel					
02	01005	0402	Α	0.4±0.02	0.2±0.02	0.2±0.02	0.07	0.14	0.13	40kp(E4/1)	_					
02	01003	0402	A	0.4±0.02	0.2±0.02	0.2±0.02	0.07	0.14	0.13	20kp(P8/2)	80kp(P8/2)					
			Υ	0.6±0.03	0.3±0.03	0.22 max.	0.1	0.2	0.2	30kp(P8/1)	1E0km/D0 /1)					
			Α	0.6±0.03	0.5±0.05	0.3±0.03	0.1	0.2	0.2		150kp(P8/1)					
			В	0.6±0.05	0.3±0.05	0.3±0.05				15kp(P8/2)	50kp(P8/2)					
03	0201	0603	Υ*			0.22 max.	0.13	0.23	0.19	15kp(P8/2)	50kp(P8/2)					
			С	0.6±0.09	0.3±0.09	0.3±0.09	0.13	0.23	0.19	13KP(F6/2)	30KP(F6/2)					
			D	0.0±0.09	0.5±0.09	0.5±0.05				10kp(P8/2)						
			D*			0.3±0.03	0.1	0.25	0.19	10κμ(+6/2)	_					
		Y		1.0±0.05	0.5±0.05	0.33 max.				10kp(P8/2)	50kp(P8/2)					
						0.5±0.05										
			X	1.0±0.1	0.5±0.05	0.22 max.]			10kp(P8/2)	50kp(P8/2)					
		0402 1005	В	1.0±0.15	0.5±0.15	0.5±0.15				10kp(P8/2)	40kp(P8/2)					
05	0402				0.33 max.	0.15	0.35 0.3	0.3	10kp(P8/2)	_						
			Z			0.5 max.]			10kp(P8/2)	50kp(P8/2)					
			Α*	1.0±0.2	0.5±0.2	0.55 max.					10kp(P8/2)	50kp(P8/2)				
			С			0.5±0.2					10kp(P8/2)	40kp(P8/2)				
			D			0.8 max.				10kp(P8/2)	30kp(P8/2)					
15	0603	1608	Α	1.6±0.1	0.8±0.1	0.8±0.1	0.2	0.6	0.6	0.6	0.6	0.6	0.6	0.5	4kp(P8/4)	10kp(P8/4)
13	0003	1000	С	1.6±0.2	0.8±0.2	0.8±0.2	0.2	0.0	0.5							
21	0805	2012	С	2.0±0.2	1.25±0.2	0.95 max.	0.2	0.75	0.7	4kp(P8/4)	10kp(P8/4)					
21	0003	2012	Α			1.25±0.2	0.2	0.73	0.7	3kp(E8/4)	10kp(E8/4)					
			L	3.2±0.2	1.6±0.2	0.95 max.]			4kp(P8/4)	_					
31	1206	3216	F	3.2±0.2	1.6±0.15	1.6±0.15	0.3	0.85	1.4	2.5kp(E8/4)	5kp(E8/4)					
31	1200	3210	Α		1.6±0.2	1.6±0.2				2.3KP(L0/4)	3KP(L0/4)					
			Н	3.2±0.3	1.6±0.3	1.6±0.3	0.3	0.85	1.9	2kp(E8/4)	_					
32	1210	3225	Α	3.2±0.3	2.5±0.2	2.5±0.2	0.3	1.0	1.4	1kp(E8/4)	4kp(E8/4)					

* If there is a "*" in the thickness code indicates the same thickness (T-dimension) but different L/W or P-dimension. Please refer to the part number list for details.

■KGN Series (Three Terminal Capacitors)



Size	Code		Thickness			Quantity per reel					
Size	EIA	JIS	Code	L	W	T	G	Р	R	φ180 Reel	φ330 Reel
KGN	0402 1	Z	Z	1.0±0.1	0.5±0.2	0.5 max.	0.3±0.1	0.15±0.1	≧0.05	10kp(P8/2)	
05		1005	В	1.0±0.15	0.5±0.15	0.5±0.15					_
05			C.	1.0±0.2	0.5±0.2	0.5±0.2					

Multilayer Ceramic Chip Capacitors



High-Q KGU Series



■ Features

Ultra-miniature size (0.4x0.2mm) Low loss characteristics suitable for high frequency

■Applications

RF power amplifier for mobiles such as impedance matching purpose.

Temperature Compensation Dielectric



●Capacitance chart ■ Standard Spec.1

Capacitance	R20	R50	1R0	1R5	2R0	3R0	4R0	5R0	6R0	7R0	8R0	9R0	100	120	150	180	220	240
Size/Voltage(Vdc)	0.2pF	0.5pF	1pF	1.5pF	2pF	3pF	4pF	5pF	6pF	7pF	8pF	9pF	10pF	12pF	15pF	18pF	22pF	24pF
	KGU02 16 A																	
(01005) 25							F	4										

Please contact for capacitance value other than standard.

Please refer to here for the test method and specifications of Standard Specification 1.

The code in the capacity range table means product thickness (T-dimension). Please refer to the below parts number list. For details about T dimensions, please refer to the Dimension section in the parts number list below.

(Example) In case of "A" for KGU02;

T: 0.2±0.02mm

Parts number list Low Loss KGU02 Series Temperature Characteristic : CΔ: CG/CH

Tolorance T: A: +0.05 pE/ P: +0.1 pE/ C: +0.25 pE/ D: +0.5 pE/ C: +2%/ I: +5%/ IV: +10%

			Tol	erance L]: A: ±0.05 p	oF/ B: ±0.1 p	F/ C: ± 0.25	pF/ D: :	±0.5 pF,	/ G: ±29	%/ J: ±5	%/ K: ±	10%		
Th: al			Tolerance	Voltago	Di	imension[mr	ml				Packag	ging: #			
Thickness code	Part Number	Capacitance	:□	1 2 1	Di	IIII	11]		Ф1	80			Ф3	30	
couc				[V]	L	W	T	code	QTY	code	QTY	code	QTY	code	QTY
Α	KGU02AC∆1ER20□#	0.2pF	A/B/C	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	_
Α	KGU02AC∆1ER50□#	0.5pF	A/B/C	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	_
Α	KGU02AC∆1E1R0□#	1pF	A/B/C	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1E1R5□#	1.5pF	A/B/C	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1E2R0□#	2pF	A/B/C	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02ACΔ1E3R0□#	3pF	A/B/C	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1E4R0□#	4pF	B/C	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	_
Α	KGU02ACΔ1E5R0□#	5pF	B/C	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	_
Α	KGU02AC∆1E6R0□#	6pF	C/D	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	_
Α	KGU02AC∆1E7R0□#	7pF	C/D	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1E8R0□#	8pF	C/D	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1E9R0□#	9pF	C/D	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	_
Α	KGU02AC∆1E100□#	10pF	G/J/K	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	_
Α	KGU02AC∆1E120□#	12pF	G/J/K	25	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	_
Α	KGU02AC∆1CR20□#	0.2pF	A/B/C	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	
Α	KGU02AC∆1CR50□#	0.5pF	A/B/C	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1C1R0□#	1pF	A/B/C	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	
Α	KGU02AC∆1C1R5□#	1.5pF	A/B/C	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1C2R0□#	2pF	A/B/C	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	
Α	KGU02AC∆1C3R0□#	3pF	A/B/C	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1C4R0□#	4pF	B/C	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	
Α	KGU02AC∆1C5R0□#	5pF	B/C	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	_
Α	KGU02AC∆1C6R0□#	6pF	C/D	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1C7R0□#	7pF	C/D	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	
Α	KGU02AC∆1C8R0□#	8pF	C/D	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	
Α	KGU02AC∆1C9R0□#	9pF	C/D	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1C100□#	10pF	G/J/K	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1C120□#	12pF	G/J/K	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1C150□#	15pF	G/J/K	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	_
Α	KGU02AC∆1C180□#	18pF	G/J/K	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	P	40kp	N	80kp	_	
Α	KGU02AC∆1C220□#	22pF	G/J/K	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp	_	
Α	KGU02AC∆1C240□#	24pF	G/J/K	16	0.4±0.02	0.2±0.02	0.2±0.02	Н	20kp	Р	40kp	N	80kp		

Multilayer Ceramic Chip Capacitors Test Conditions and Standards



Specifications and Test Conditions for Temperature Compensation Type (C Δ Characteristics) KGM/KGT/KGU Series (Standard Spec.1)

Test	Items	Specifications	Test Conditions (Complies with JIS C5101/ IEC60384)					
Capacitance		Within tolerance	Capacitance Frequency Voltage					
Q		C≥30pF : Q≥1000 C<30pF : Q≥400+20C	C>1000pF 1MHz±10% 0.5 to 5Vrms					
Insulation Resistance		Over $10000 \text{M}\Omega$ or $500 \text{M}\Omega$ • μF , whichever is less	Measure after applying rated voltage for 1 minute in normal temperature and humidity. The charge and discharge current of the capacitor must not exceed 50mA.					
Dielectric Strength		Resist without problem	Apply*3 times of the rated voltage for 1 to 5 seconds. *KGU02ACΔ1ER20-120: twice The charge and discharge current of the capacitor must not exceed 50mA.					
Appearance		No problem observed	Microscope					
Termination Str	ength	No problem observed	Apply a sideward force of 5N to a PCB-mounted sample. note: 1N for 01005 size.					
Bending Streng	th	No significant damage with 1mm bending.	Glass epoxy PCB (90mm fulcrum spacing), 10 seconds duration time.					
Vibration	Appearance	No problem observed	Vibration frequency: 10 to 55 (Hz)					
	Capacitance	Within Tolerance	Amplitude: 1.5mm Sweeping condition: 10→55→10Hz/ 1 minute in X, Y and Z directions: 2					
	Q	C≥30pF: Q≥1000 C<30pF: Q≥400+20C	hours each, 6 hours in total.					
Resistance to	Appearance	No problem observed	6 1 1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2					
Solder Heat	Capacitance Variation	Within±2.5% or±0.25pF, whichever is larger	Soak the sample in 260±5°C solder for 10±0.5 seconds, and measure afte resting in normal temperature and humidity for 24±2 hours. (Pre-heating conditions before soak)					
	Q	C≥30pF: Q≥1000 C<30pF: Q≥400+20C	Order Temperature Time					
	Insulation	, -	1 80 to 100°C 2 minutes					
	Resistance	Over $10000M\Omega$ or $500M\Omega \cdot \mu F$ whichever is less	2 150 to 200°C 2 minutes The charge and discharge current of the capacitor must not exceed 50mA					
	Dielectric strength	Resist without problem	for IR and dielectric strength measurement.					
Solderability		Solder coverage : 95% min.	Soaking condition Solder Type Temperature Time Sn-3Ag-0.5Cu 245±5°C 3±0.5 sec.					
Temperature	Appearance	No problem observed						
Cycle	Capacitance Variation	Within±2.5% or ±0.25pF, whichever is larger	(Cycle) Lowest operation temperature (30 min.)→					
	Q	C≥30pF: Q≥1000 C<30pF: Q≥400+20C	Room temperature (3 min.) → Highest operation temperature (30 min.) → Room temperature (3 min.)					
	Insulation Resistance	Over $10000M\Omega$ or $500M\Omega \cdot \mu F$, whichever is less	After 5 cycles, measure after 24±2 hours. The charge and discharge current of the capacitor must not exceed 50mA					
	Dielectric Strength	Resist without problem	for IR and dielectric strength measurement.					
Load Humidity	Appearance	No problem observed						
	Capacitance Variation	Within±7.5% or ±0.75pF, whichever is larger	Apply the rated voltage for 500+12/ –0 hours in the condition of 40±2°C and 90 to 95%RH, and measure after resting in normal temperature and					
	Q	C≥30pF: Q≥200 C<30pF: Q≥100+10C/ 3	humidity for 24±2 hours. The charge and discharge current of the capacitor must not exceed 50mA					
	Insulation Resistance	Over 500M Ω or 25M Ω • μ F, whichever is less	for IR measurement.					
Load Life	Appearance	No problem observed.						
	Capacitance Variation	Within ±3% or ±0.3pF, whichever is larger	Apply *twice the rated voltage in 125±3°C for 1000+12/ –0 hours, and					
	Q	C≥30pF : Q≥350 10pF <c<30pf 2<br="" :="" q≥275+5c="">C<10pF : Q≥200+10C</c<30pf>	measure after resting in normal temperature and humidity for 24±2 hours. The charge and discharge current of the capacitor must not exceed 50mA for IR measurement. *Products listed below shall apply each indicated voltage.					

Voltage to be applied in the Load Life (Applied voltage is the multiple of the rated voltage)

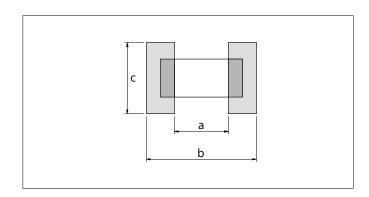
Applied Vol	age Rated Voltage	Products
×1.2	25V	KGU02ACΔ1ER20-120

Multilayer Ceramic Chip Capacitors Test Conditions and Standards



Substrate for Adhesion Strength Test, Vibration Test, Soldering Heat Resistance Test, Temperature Cycle Test, Load Humidity Test, High-Temperature with Loading Test.

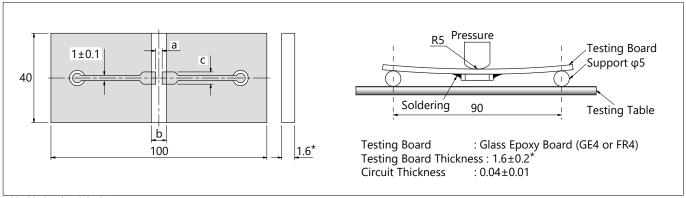
(Unit: mm)



Size (EIA Code)	a	b	С
02 (01005)	0.15	0.5	0.2
03 (0201)	0.26	0.92	0.32
05 (0402)	0.4	1.4	0.5
15 (0603)	1.0	3.0	1.2
21 (0805)	1.2	4.0	1.65
31 (1206)	2.2	5.0	2.0
32 (1210)	2.2	5.0	2.9

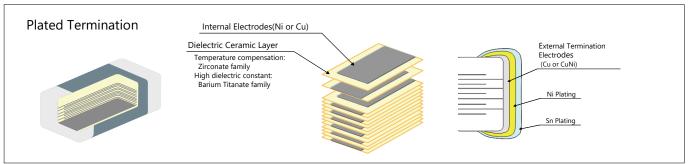
Substrate for Bending Test

(Unit: mm)



* 02, 03, 05 size 0.8±0.1mm

Structure



■Certification status

<ISO>

Acquired ISO 9001 quality management system certification.

<IATF:

Acquired IATF 16949 quality management system certification.

■Production plant

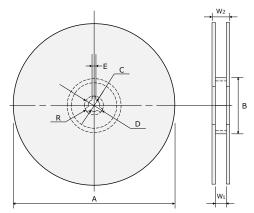
Kagoshima Kokubu plant

Multilayer Ceramic Chip Capacitors Packaging Options Tape and Reel



(Unit: mm)

Reel

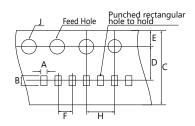


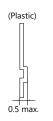
Code Reel	А	В	С	D		
7-inch Reel (CODE: T, H, Q, U)	180 +0 -2.0					
7-inch Reel (CODE: P)	178±2.0	φ60 min.	13±0.5	21±0.8		
13-inch Reel (CODE: L, M, N, W)	330±2.0					
Code Reel	E	W 1	W2	R		
7-inch Reel (CODE: T, H, Q, U)	U) 10.5±1.5		16.5 max.			
7-inch Reel (CODE: P)	2.0±0.5	4.35±0.3	6.95±1.0	1.0		
13-inch Reel (CODE: L. M. N. W)		9.5±1.0	16.5 max.			

Carrier Tape (Unit: mm)

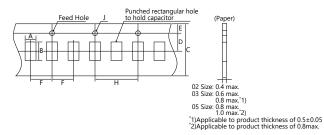
F=1mm (02 Size)

F=1mm (03 Size)

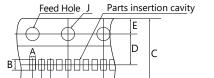


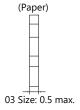


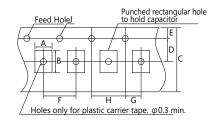
F=2mm (02, 03, 05 Size)

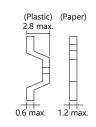


F=4mm (15, 21, 31, 32 Size)









(Unit: mm)

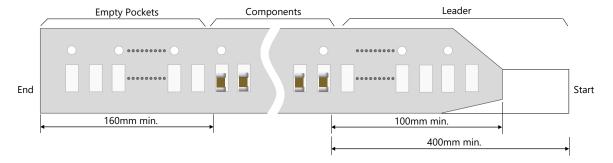
Size (EIA Code)	А	В	С	D	E	F	G	Н	J	Carrie Width	r Tape Material
02 (01005)*	0.24±0.02	0.44±0.02	4.0±0.08	1.8±0.02	0.9±0.05	1.0±0.02		2.0±0.04	0.8±0.04	4	Plastic
02 (01005)*	0.25±0.03	0.45±0.03	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	1 -	4.0±0.1	1.5+0.1/-0	8	Paper
	0.37±0.03	0.67±0.03	8.0+0.3/-0.1	3.5±0.05	1.75±0.1	1.0±0.05		4.0±0.05	1.5+0.1/-0		
	0.37±0.03	0.67 ± 0.03	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	_	4.0±0.1	1.5+0.1/-0		
03 (0201)*	0.39±0.03	0.69±0.03	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	_	4.0±0.1	1.5+0.1/-0	8	Paper
	0.42±0.03	0.72±0.03	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	_	4.0±0.1	1.5+0.1/-0		
	0.44±0.05	0.74±0.05	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	_	4.0±0.1	1.5+0.1/-0		
	0.65±0.1	1.15±0.1	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05		4.0±0.1	1.5+0.1/-0		
05 (0402)*	0.75±0.1	1.15±0.1	0.0±0.5	3.3±0.03	1.73±0.1	2.0±0.03	_	4.0±0.1	1.5+0.1/-0	8	Paper
	0.8±0.1	1.3±0.1	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	_	4.0±0.1	1.5+0.1/-0	1	
15 (0602)*	1.0±0.2	1.8±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5+0.1/-0	8	Paper
15 (0603)*	1.1±0.2	1.9±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5+0.1/-0	0	Гареі
21 (0805)	1.5±0.2	2.3±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5+0.1/-0	8	Paper
21 (0003)	1.5±0.2	2.3±0.2	0.0±0.5	3.3±0.03	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5+0.1/-0	8	Plastic
31 (1206)	2.0±0.2	26+02	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	15+01/-0	8	Paper
31 (1206)	2.U±U.2	3.6±0.2	0.U±U.3	3.5±0.05	1./5±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5+0.1/-0	8	Plastic
32 (1210)	2.9±0.2	3.6±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5+0.1/-0	8	Plastic

^{*} Option

Multilayer Ceramic Chip Capacitors Packaging Options

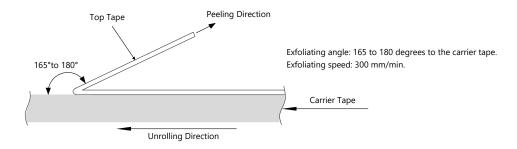


Detail of leader and trailer



Adhesive tape

- 1) The exfoliative strength when peeling off the top tape from the carrier tape by the method of the following figure shall be *0.1 to 0.7N. *02 Size: 0.1 to 0.5N
- 2) When the top tape is peeled off, the adhesive stays on the top tape.
- 3) Chip capacitors will be in a state free without being stuck on the thermal adhesive tape.



Carrier tape

- 1) Chip will not fall off from carrier tape or carrier tape will not be damaged by bending than within a radius of 25mm.
- 2) The chip are inserted continuously without any empty pocket.
- 3) Chip will not be mis-mounted because of too big clearance between components and cavity. Also the waste of carrier tape will not fill a nozzle hole of mounting machine.

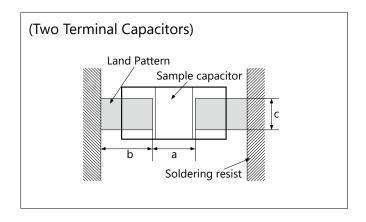
Multilayer Ceramic Chip Capacitors Surface Mounting Information



Dimensions for recommended typical land

Since the amount of solder (size of fillet) to be used has direct influence on the capacitor after mounting, the sufficient consideration is necessary.

When the amounts of solder is too much, the stress that a capacitor receives becomes larger. It may become the cause of a crack in the capacitor. When the land design of printed wiring board is considered, it is necessary to set up the form and size of land pattern so that the amount of solder is suitable.



Two Terminal Capacitors

(Unit: mm)

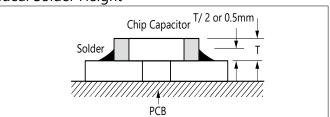
Size	Dime	nsion	Recomme	ended land di	mensions	
(EIA Code)	L	W	a	b	С	
02 (01005)	02 (01005) 0.4±0.02 0.2±0.		0.13 to 0.2	0.12 to 0.18	0.2 to 0.23	
	0.6±0.03	0.3±0.03	0.2 to 0.25	0.25 to 0.35	0.3 to 0.4	
03 (0201)	0.6±0.05	0.3±0.05	0.2 10 0.25	0.25 (0 0.35	0.3 10 0.4	
	0.6±0.09	0.3±0.09	0.23 to 0.3	0.25 to 0.35	0.3 to 0.45	
	1.0±0.05	0.5±0.05	0.3 to 0.5	0.35 to 0.45	0.4 to 0.6	
05 (0402)	1.0±0.15	0.5±0.15	0.4 to 0.6	0.4 to 0.5	0.5 to 0.75	
	1.0±0.2	0.5±0.2	0.4 10 0.6	0.4 (0 0.5	0.5 10 0.75	
15 (0603)	1.6±0.1	0.8±0.1	0.7 to 1.0	0.8 to 1.0	0.6 to 0.9	
15 (0005)	1.6±0.2	0.8±0.2	0.8 to 1.0	0.8 to 1.0	0.8 to 1.1	
21 (0805)	2.0±0.2	1.25±0.2	1.0 to 1.3	1.0 to 1.2	1.25 to 1.55	
	3.2±0.2	1.6±0.15	2.1 to 2.5	1.1 to 1.3	1.4 to 1.9	
31 (1206)	3.2±0.2	1.6±0.2	2.1 to 2.5	1.1 to 1.3	164-20	
	3.2±0.3	1.6±0.3	2.1 (0 2.5	1.1 (0 1.3	1.6 to 2.0	
32 (1210)	3.2±0.3	2.5±0.2	2.1 to 2.5	1.1 to 1.3	1.9 to 2.8	

^{*} Recommended land dimensions may differ depending on dimensional tolerance.

Design of printed circuit and Soldering

The recommended fillet height shall be 1/2 of the thickness of capacitors or 0.5mm. When mounting two or more capacitors in the common land, it is necessary to separate the land with the solder resist strike so that it may become the exclusive land of each capacitor.

Ideal Solder Height



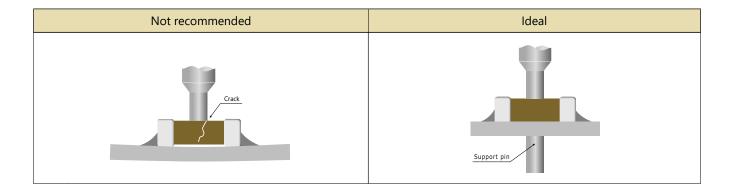
Item	Prohibited	Recommended example : Separation by solder resist			
Multiple parts mount		Solder resist			
Mount with leaded parts	Leaded parts	Solder resist Leaded parts Leaded parts			
Wire soldering after mounting	Soldering iron Wire	Solder resist			
Side by side layout	Solder resist	Solder resist			

Multilayer Ceramic Chip Capacitors Surface Mounting Information



Actual Mounting

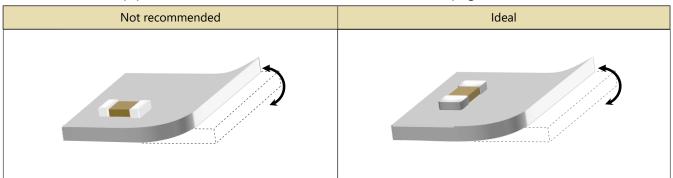
- 1) If the position of the vacuum nozzle is too low, a large force may be applied to the chip capacitor during mounting, resulting in cracking.
- 2) During mounting, set the nozzle pressure to a static load of 1 to 3 N.
- 3) To minimize the shock of the vacuum nozzle, provide a support pin on the back of the PCB to minimize PCB flexure.
- 4) Bottom position of pick up nozzle should be adjusted to the top surface of a substrate which camber is corrected.



Mounting Design

The chip could crack if the PCB warps during processing after the chip has been soldered.

Recommended chip position on PCB to minimize stress from PCB warpage

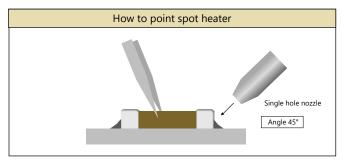


Soldering Method

- 1) Ceramic is easily damaged by rapid heating or cooling. If some heat shock is unavoidable, preheat enough to limit the temperature difference (Delta T) to within 150 degree Celsius.
- 2) The product size 1.6×0.8mm to 3.2×1.6mm can be used in reflow and wave soldering, and the product size of bigger than 3.2×1.6mm, or smaller than 1.6×0.8mm can be used in reflow.
 - Circuit shortage and smoking can be created by using capacitors which are used neglecting the above caution.
- 3) Please see our recommended soldering conditions.
- 4) In case of using Sn-Zn Solder, please contact us in advance.
- 5) The following condition is recommended for spot heater application.

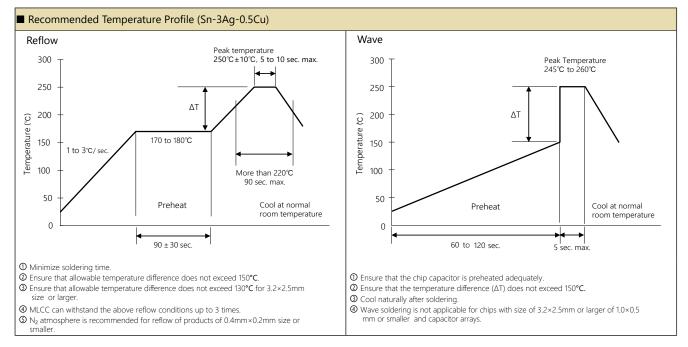
· Recommended spot heater condition

Item	Condition					
Distance	5mm min.					
Angle	45°					
Projection Temp.	400°C max.					
Flow rate	Set at the minimum					
Nozzle diameter	2φ to 4φ (Single hole type)					
Application time	10 sec. max. (1206 and smaller) 30 sec. max. (1210 and larger)					



Multilayer Ceramic Chip Capacitors Surface Mounting Information





Resin Mold

- 1) If a large amount of resin is used for molding the chip, cracks may occur due to contraction stress during curing. To avoid such cracks, use a low shrinkage resin.
- 2) The insulation resistance of the chip will degrade due to moisture absorption. Use a low moisture absorption resin.
- 3) Check carefully that the resin does not generate a decomposition gas or reaction gas during the curing process or during normal storage. Such gases may crack the chip capacitor or damage the device itself.

Multilayer Ceramic Chip Capacitors **Precautions**



Circuit Design

- 1. Once application and assembly environments have been checked, the capacitor may be used in conformance with the rating and performance which are provided in both the catalog and the specifications. Use exceeding that which is specified may result in inferior performance or cause a short, open, smoking, or flaming to occur, etc.
- 2. Please consult the manufacturer in advance when the capacitor is used in devices such as: devices which deal with human life, i.e. medical devices; devices which are highly public orientated; and devices which demand a high standard of liability. Accident or malfunction of devices such as medical devices, space equipment and devices having to do with atomic power could generate grave consequence with respect to human lives or, possibly, a portion of the

public. Capacitors used in these devices may require high reliability design different from that of general purpose capacitors.

3. Please use the capacitors in conformance with the operating temperature provided in both the catalog and the

Be especially cautious not to exceed the maximum temperature. In the situation the maximum temperature set forth in both the catalog and specifications is exceeded, the capacitor's insulation resistance may deteriorate, power may suddenly surge and short-circuit may occur.

The capacitor has a loss, and may self-heat due to equivalent series resistance when alternating electric current is passed therethrough. As this effect becomes especially pronounced in high frequency circuits, please exercise caution.

When using the capacitor in a (self-heating) circuit, please make sure the surface of the capacitor remains under the maximum temperature for usage. Also, please make certain temperature rises remain below 20°C.

- 4. Please keep voltage under the rated voltage which is applied to the capacitor. Also, please make certain the peak voltage remains below the rated voltage when AC voltage is super-imposed to the DC voltage. In the situation where AC or pulse voltage is employed, ensure average peak voltage does not exceed the rated voltage. Exceeding the rated voltage provided in both catalog and specifications may lead to defective withstanding voltage or, in worst case situations, may cause the capacitor to smoke or flame.
- 5. When the capacitor is to be employed in a circuit in which there is continuous application of a high frequency voltage or a steep pulse voltage, even though it is within the rated voltage, please inquire to the manufacturer. In the situation the capacitor is to be employed using a high frequency AC voltage or a extremely fast rising pulse voltage, even though it is within the rated voltage, it is possible capacitor reliability will deteriorate.
- 6. It is a common phenomenon of high-dielectric products to have a deteriorated amount of static electricity due to the application of DC voltage. Due caution is necessary as the degree of deterioration varies depending on the quality of capacitor materials, capacity, as well as the load voltage at the time of operation.
- 7. Do not use the capacitor in an environment where it might easily exceed the respective provisions concerning shock and vibration specified in the catalog and specifications. In addition, it is a common piezo phenomenon of high dielectric products to have some voltage due to vibration or to have noise due to voltage change. Please contact sales in such case.
- 8. If the electrostatic capacity value of the delivered capacitor is within the specified tolerance, please consider this when designing the respective product in order that the assembled product function appropriately.
- 9. Please contact us upon using conductive adhesives.

Storage

Please note the following regarding the storage of delivered products.

- 1. Set the storage temperature to + 5 to + 40 °C and humidity to 20 ~ 70% RH. Other meteorological conditions are in accordance with classification 1 K2 of JIS C 60721 -3 -1.
- 2. Store in a place where corrosive gas (H₂S, SO₂, NO₂, Cl₂, etc.) does not exist in the atmosphere. Also, avoid exposure to salty moisture. In either case, this may cause oxidation corrosion of the terminal electrode, reducing solderability.

If you store the above delivered products according to the conditions listed above, it will satisfy the solderability standard for 6 months from the shipping date.

Safety application guideline and detailed information of electrical properties are also provided in kyocera web site;

URL: https://ele.kyocera.com/en/product/capacitor/



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- 1. Contents described herein are as of April 2025.
- 2. Contents in this catalog are subject to change without notice. It is recommended to confirm the latest information at the time of usage. We may not be able to accept requests based on old catalogs.
- 3. The products described in this catalog are intended for use in general electronic equipment (Information equipment, communication equipment, audio and video equipment, measurement equipment, home appliances, automotive equipment, etc.). If you plan to use the product in any equipment or system that requires special quality and reliability of those beyond catalog spec and whose failure or malfunction may directly threaten human life or cause physical harm (Safety equipment, aerospace, nuclear power control, medical equipment including life support equipment, etc.), please contact our company sales representative before using the product.
- 4. Even though we strive for improvements of quality and reliability of products, it is requested to design with enough safety margin in equipment or systems in order not to threaten human lives directly or damage human bodies or properties by an accidental result of products.
- 5. It is requested to design based on guaranteed specifications for such as maximum ratings, operating voltage and operating temperature. It is not the scope of our guarantee for unsatisfactory results due to misuse or inadequate usage of products in this catalog.
- 6. Operation summaries and circuit examples in this catalog are intended to explain typical operation and usage of the product. It is recommended to perform circuit and assembly design considering surrounding conditions upon using products in this catalog.
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